

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Logic-level compatible
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

3. Applications

- DC-to-DC converters
- Battery management
- Low-side load-switch
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	30	V
V _{GS}	gate-source voltage	-		-20	-	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-	22	А
Static chara	acteristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 14.2 A; T _j = 25 °C		-	4.6	5.4	mΩ
		V _{GS} = 4.5 V; I _D = 12.3 A; T _j = 25 °C		-	5.8	7.2	mΩ
Dynamic ch	naracteristics						
Q _{G(tot)}	total gate charge	V_{DS} = 15 V; I _D = 12.3 A; V _{GS} = 4.5 V; T _j = 25 °C		-	11.6	17.4	nC

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

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5. Pinning information

Table 2	Fable 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol					
1	S	source		D					
2	S	source							
3	S	source		G-U=A					
4	G	gate	— П П	mbb076 S					
5	D	drain							
6	D	drain							
7	D	drain	MLPAK33 (SOT8002-1)						
8	D	drain							

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PXN5R4-30QL	MLPAK33	plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1			

7. Marking

Table 4. Marking codes	
Type number	Marking code
PXN5R4-30QL	8AP

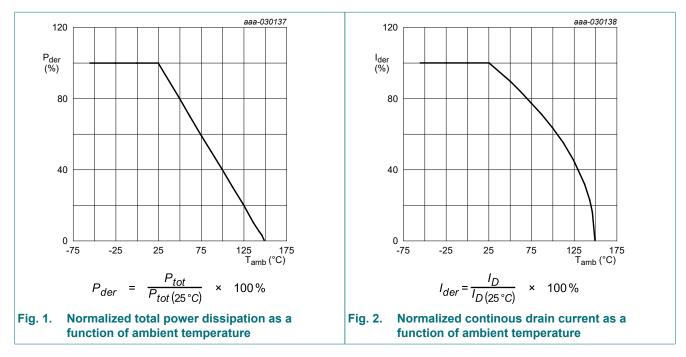
8. Limiting values

Table 5. Limiting values

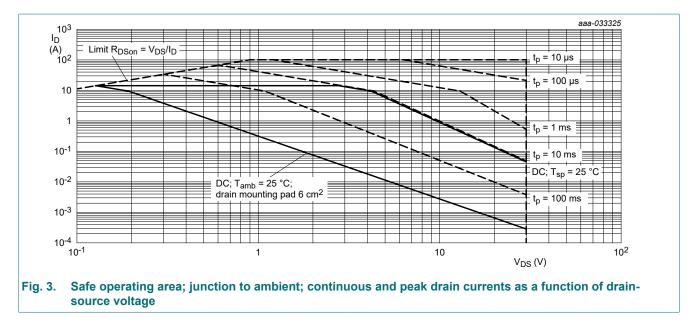
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	30	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	22	А
		V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	14	А
		V _{GS} = 10 V; T _{amb} = 100 °C	[1]	-	9	А
		V _{GS} = 10 V; T _{sp} = 25 °C		-	66	А
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	101	А
P _{tot}	total power dissipation	T _{amb} = 25 °C; t ≤ 5 s	[1]	-	4.5	W
		T _{amb} = 25 °C	[1]	-	1.8	W
		T _{sp} = 25 °C		-	39	W
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drai	n diode					
I _S	source current	T _{amb} = 25 °C	[1]	-	1.8	А

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².



30 V, N-channel Trench MOSFET



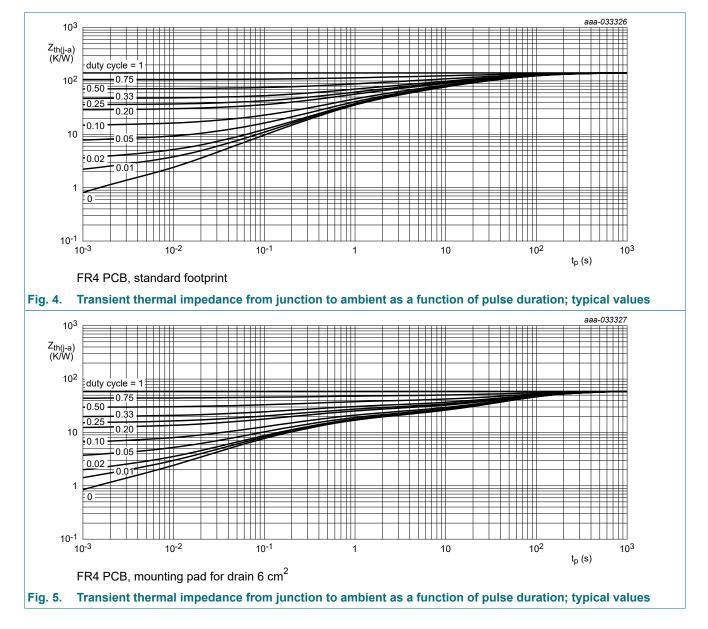
PXN5R4-30QL

9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient		[1]	-	145	185	K/W
			[2]	-	55	70	K/W
		in free air; t ≤ 5 s	[2]	-	23	28	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	2.3	3.2	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

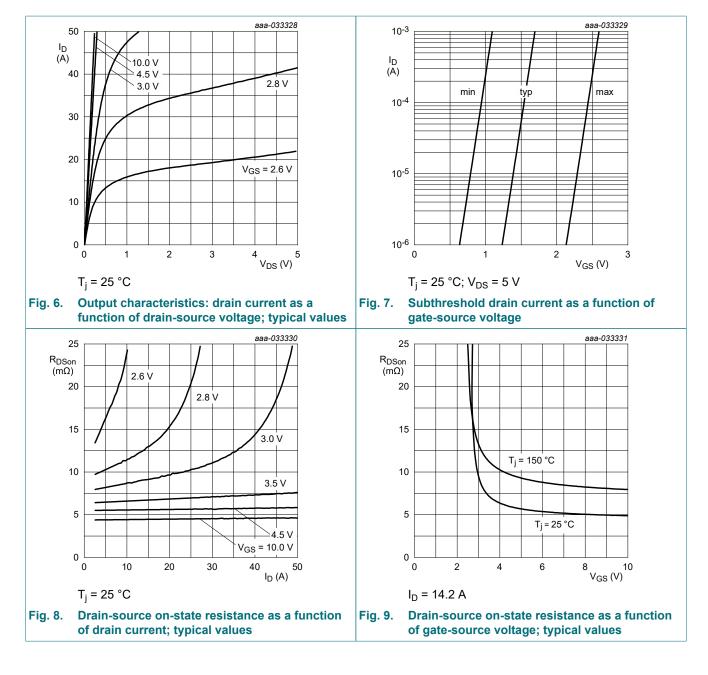
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



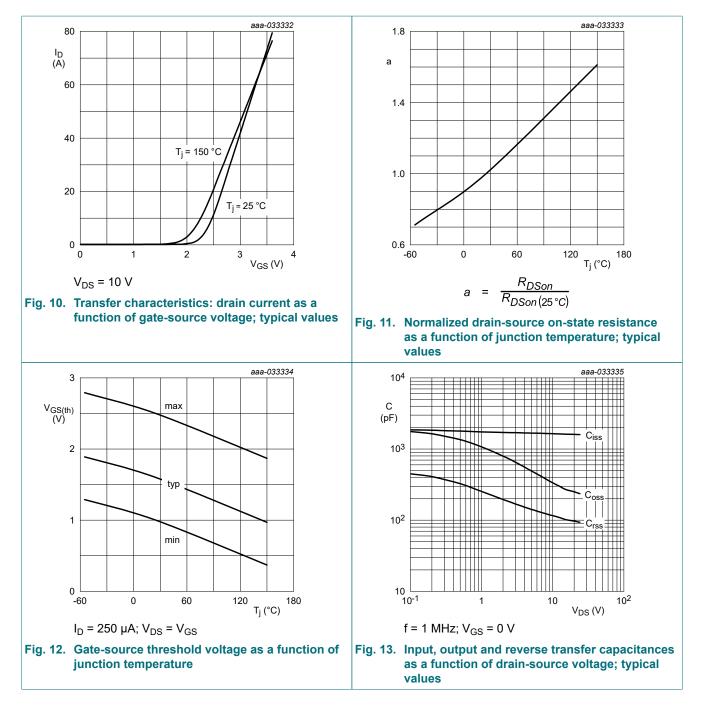
10. Characteristics

$ \begin{array}{ c c c c c } \hline voltage & voltag$	Unit	Max	Тур	Min	Conditions	Parameter	Symbol
breakdown voltage						cteristics	Static chara
$ \begin{array}{ c c c c c c } \hline \mbox{voltage} & \$	V	-	-	30	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C		V _{(BR)DSS}
	V	2.5	1.6	1	I _D = 250 μA; V _{DS} = V _{GS} ; T _j = 25 °C	•	V _{GSth}
$ \begin{array}{ c c c c c c c } \hline \begin{tabular}{ c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	μA	1	-	-	V _{DS} = 30 V; V _{GS} = 0 V; T _j = 25 °C	drain leakage current	I _{DSS}
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	nA	100	-	-	V_{GS} = 20 V; V_{DS} = 0 V; T_j = 25 °C	gate leakage current	I _{GSS}
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	nA	-100	-	-	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C		
$ \frac{V_{GS} = 10 \text{ V; } \text{ Ip } = 14.2 \text{ A; } \text{ Ij } = 150 \text{ C} & - & 7.5 & 8.5 \\ \hline V_{GS} = 4.5 \text{ V; } \text{ Ip } = 12.3 \text{ A; } \text{ Tj } = 25 ^{\circ}\text{C} & - & 5.8 & 7.2 \\ \hline V_{GS} = 4.5 \text{ V; } \text{ Ip } = 14.2 \text{ A; } \text{ Tj } = 25 ^{\circ}\text{C} & - & 37 & - \\ \hline R_G & \text{gate resistance} & f = 1 \text{ MHz} & - & 0.6 & - \\ \hline Dynamic characteristics \\ \hline Q_{G(tol)} & \text{total gate charge} & \frac{V_{DS} = 15 \text{ V; } \text{ Ip } = 14.2 \text{ A; } \text{ V}_{GS} = 10 \text{ V; } \\ \hline T_j = 25 ^{\circ}\text{C} & & - & 11.6 & 17 \\ \hline V_{DS} = 15 \text{ V; } \text{ Ip } = 12.3 \text{ A; } \text{ V}_{GS} = 4.5 \text{ V; } \\ \hline R_G & \text{gate-source charge} & & & & & & & & & & & & & & & & & & &$	mΩ	5.4	4.6	-	V _{GS} = 10 V; I _D = 14.2 A; T _j = 25 °C	drain-source on-state	R _{DSon}
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	mΩ	8.9	7.5	-	V _{GS} = 10 V; I _D = 14.2 A; T _j = 150 °C	resistance	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	mΩ	7.2	5.8	-	V _{GS} = 4.5 V; I _D = 12.3 A; T _j = 25 °C		
	S	-	37	-	V _{DS} = 10 V; I _D = 14.2 A; T _j = 25 °C		9fs
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Ω	-	0.6	-	f = 1 MHz	gate resistance	R _G
$ \begin{array}{ c c c c c c c } \hline T_{j} = 25 \ ^{\circ}\text{C} & & & & & & & & & & & & & & & & & & &$	I			I	,	aracteristics	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	nC	36.3	24.2	-		total gate charge	Q _{G(tot)}
$ \begin{array}{ c c c c c } \hline \mbox{QGS} & \mbox{gate-source charge} & \mbox{Picture charge} & \mbox{Picure charge} & $	nC	17.4	11.6	-			
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	nC	-	4	-	T _j = 25 °C	gate-source charge	Q _{GS}
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	nC	-	2	-			Q _{GS(th)}
	nC	-	2	-			Q _{GS(th-pl)}
$ \begin{array}{c c c c c c c } \hline voltage & vol$	nC	-	3.3	-		gate-drain charge	Q _{GD}
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	V	-	2.6	-	V _{DS} = 15 V; I _D = 12.3 A; T _j = 25 °C	-	V _{GSpl}
$ \begin{array}{c cccc} C_{OSS} & Output capacitance \\ C_{rss} & reverse transfer \\ capacitance \\ t_{d(on)} & turn-on delay time \\ t_{r} & rise time \\ t_{d(off)} & turn-off delay time \\ t_{f} & fall time \\ \end{array} \\ \begin{array}{c cccccc} V_{DS} = 15 \ V; \ I_{D} = 12.3 \ A; \ V_{GS} = 4.5 \ V; \\ R_{G(ext)} = 5 \ \Omega; \ T_{j} = 25 \ ^{\circ}C \\ \hline & - & 13 \\ - & 11 \\ \hline & - & 5 \\ \end{array} \\ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	pF	-	1600	-		input capacitance	C _{iss}
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	pF	-	270	-	T _j = 25 °C	output capacitance	C _{oss}
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	pF	-	98	-			C _{rss}
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	ns	-	9	-		turn-on delay time	t _{d(on)}
t _f fall time - 5 - Source-drain diode	ns	-	13	-	R _{G(ext)} = 5 Ω; T _j = 25 °C	rise time	t _r
Source-drain diode	ns	-	11	-		turn-off delay time	t _{d(off)}
	ns	-	5	-	1 –	fall time	t _f
				1	· ·	n diode	Source-drai
V_{SD} source-drain voltage $I_{S} = 1.8 \text{ A}; V_{GS} = 0 \text{ V}; T_{j} = 25 \text{ °C}$ - 0.7 1.2	V	1.2	0.7	-	I _S = 1.8 A; V _{GS} = 0 V; T _j = 25 °C	source-drain voltage	V _{SD}
I_{rr} reverse recovery time $I_S = 1.8 \text{ A}; \text{ dI}_S/\text{dt} = -100 \text{ A}/\mu\text{s};$ - 18 -	ns	-	18	-		reverse recovery time	
Q_r recovered charge $V_{GS} = 4.5 \text{ V}; V_{DS} = 15 \text{ V}; T_j = 25 \text{ °C}$ - 11 -	nC	-	11	-	V _{GS} = 4.5 V; V _{DS} = 15 V; T _j = 25 °C	recovered charge	
t _a reverse recovery rise time - 12 -	ns	-	12	-	1	-	t _a
t _b reverse recovery fall time - 6 -	ns	-	6	-	1		t _b

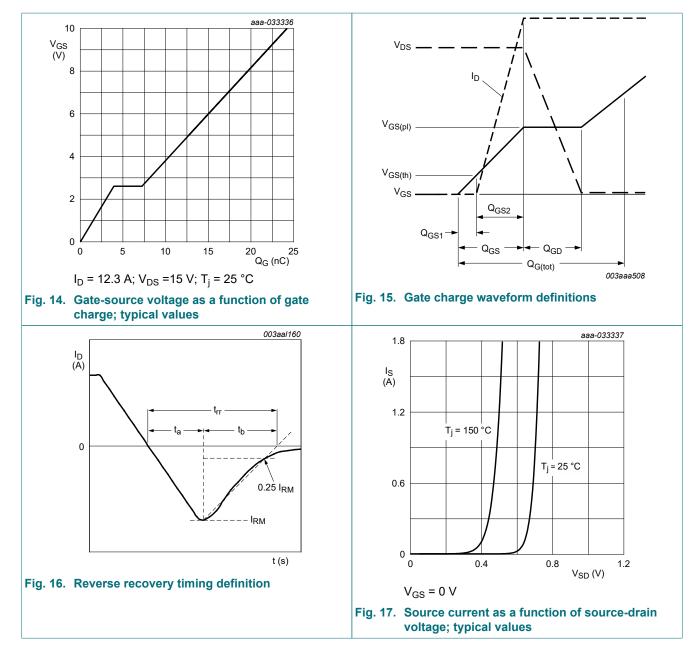
30 V, N-channel Trench MOSFET



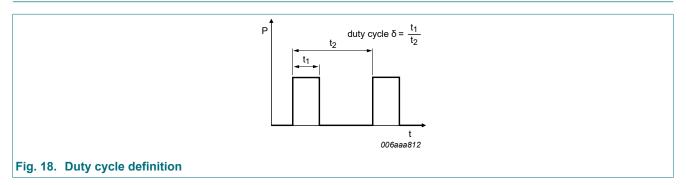
30 V, N-channel Trench MOSFET



30 V, N-channel Trench MOSFET



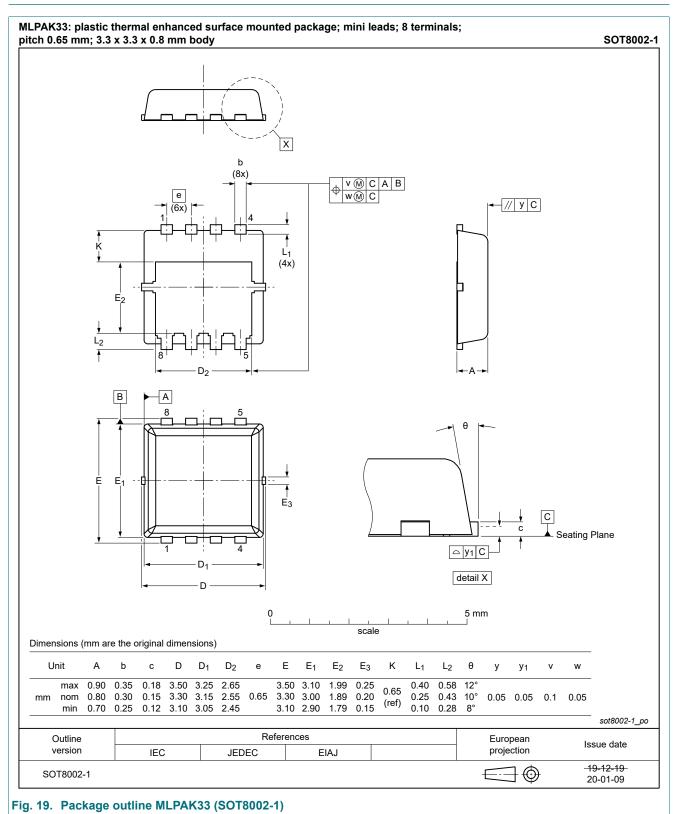
11. Test information



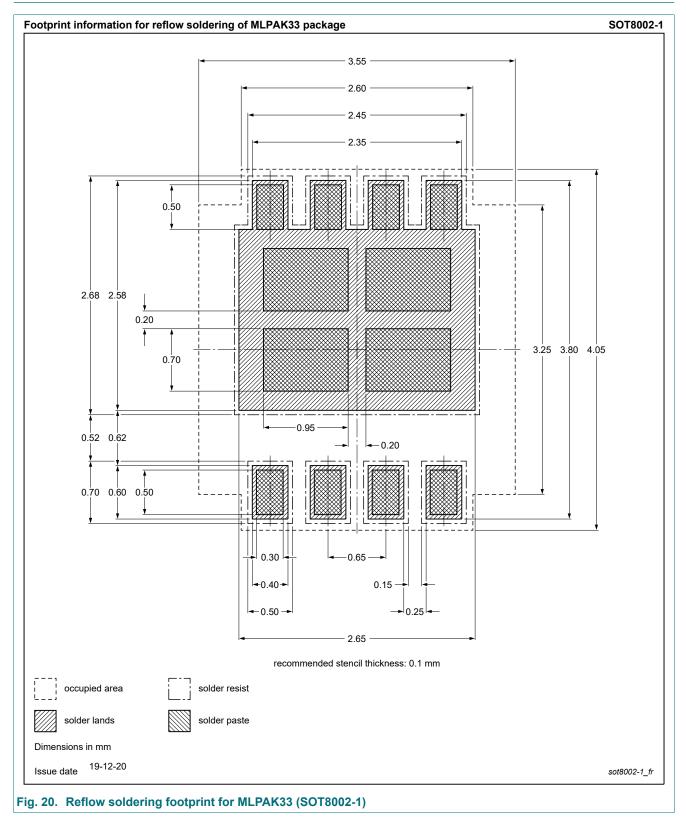
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12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PXN5R4-30QL v.1	20210415	Product data sheet	-	-		

PXN5R4-30QL

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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